100 V, 3.0 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e^2 PowerEdge family of low $V_{CE(sat)}$ transistors are surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Symbol	Max	Unit		
V _{CBO}	140	Vdc		
V _{CEO}	100	Vdc		
V _{EB}	6.0	Vdc		
Ι _C	3.0 6.0	Adc		
Ι _Β	0.5	Adc		
P _D	33 0.26	W W/°C		
P _D	2.1 0.017	W W/°C		
T _J , T _{stg}	-65 to +150	°C		
	V _{CBO} V _{CEO} V _{EB} I _C I _B P _D P _D	$\begin{array}{c c} V_{CBO} & 140 \\ \hline V_{CEO} & 100 \\ \hline V_{EB} & 6.0 \\ \hline I_C & 3.0 \\ 6.0 \\ \hline I_B & 0.5 \\ \hline P_D & 33 \\ 0.26 \\ \hline P_D & 2.1 \\ 0.017 \end{array}$		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

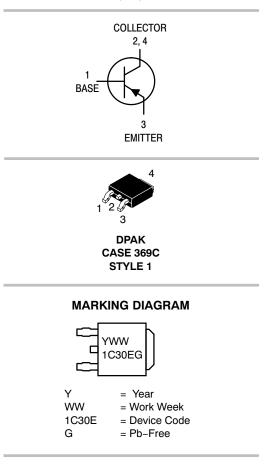
1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.



ON Semiconductor®

http://onsemi.com

100 VOLTS, 3.0 AMPS 12.5 WATTS PNP LOW V_{CE(sat)} TRANSISTOR



ORDERING INFORMATION

Device	Package	Shipping [†]
NSS1C300ET4G	DPAK (Pb-Free)	2500/ Tape & Reel
NSV1C300ET4G	DPAK (Pb-Free)	2500/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ hetaJC}$	3.8	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	59.5	°C/W

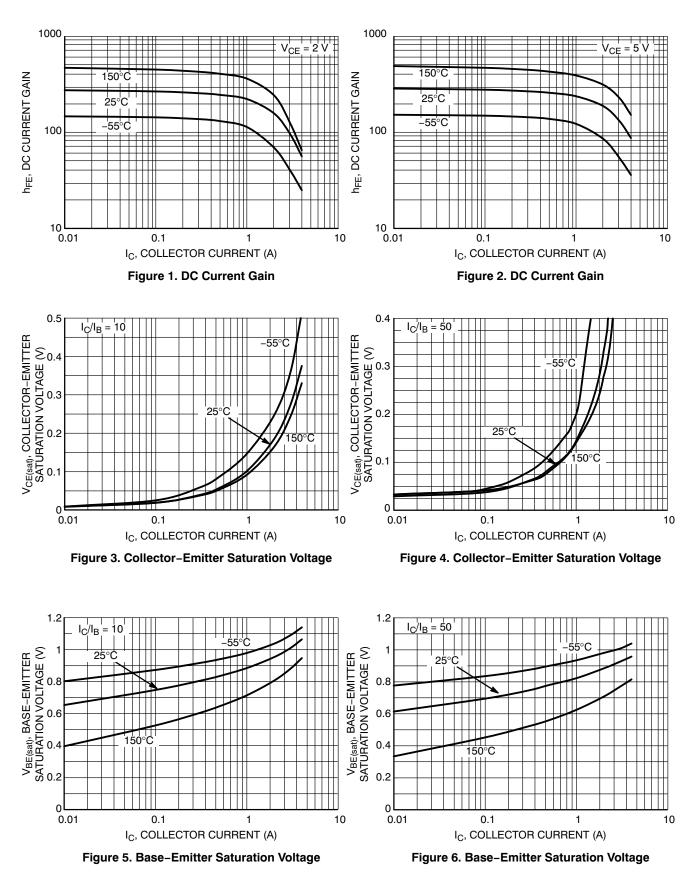
2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

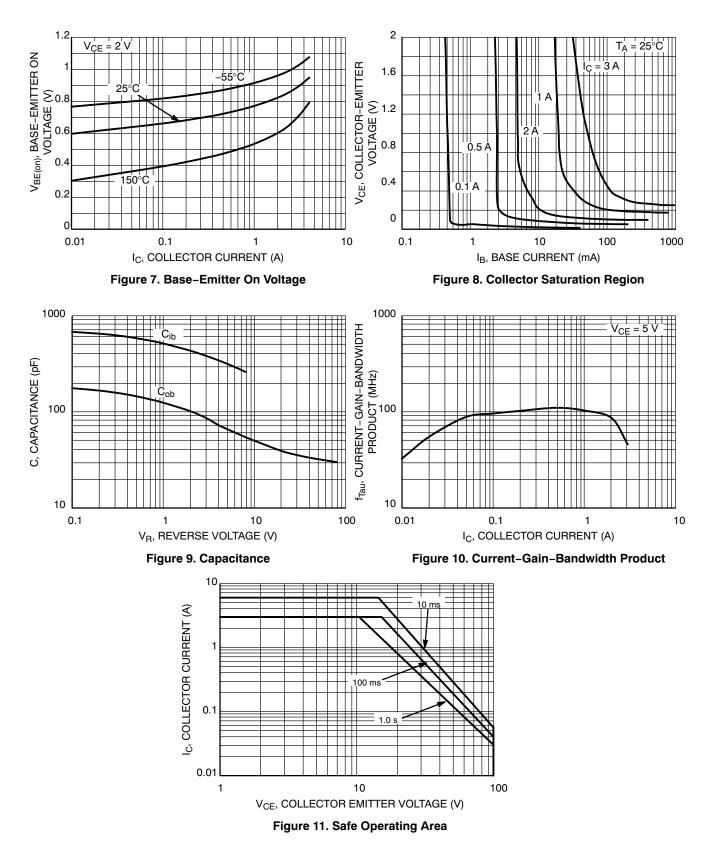
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•		
Collector – Emitter Breakdown Voltage ($I_C = -10$ mAdc, $I_B = 0$)	V _{(BR)CEO}	-100			Vdc
Collector – Base Breakdown Voltage ($I_C = -0.1 \text{ mAdc}, I_E = 0$)	V _{(BR)CBO}	-140			Vdc
Emitter – Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}, I_C = 0$)	V _{(BR)EBO}	-6.0			Vdc
Collector Cutoff Current ($V_{CB} = -140$ Vdc, $I_E = 0$)	I _{CBO}			-0.1	μAdc
Emitter Cutoff Current (V _{EB} = -6.0 Vdc)	I _{EBO}			-0.1	μAdc
ON CHARACTERISTICS			•	•	
DC Current Gain (Note 3) ($I_C = -0.1 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -0.5 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -3.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	h _{FE}	180 180 120 50		360	
Collector – Emitter Saturation Voltage (Note 3) ($I_C = -0.1 \text{ A}, I_B = -10 \text{ mA}$) ($I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$) ($I_C = -2.0 \text{ A}, I_B = -0.200 \text{ A}$) ($I_C = -3.0 \text{ A}, I_B = -0.300 \text{ A}$)	V _{CE(sat)}			-0.070 -0.150 -0.250 -0.400	V
Base – Emitter Saturation Voltage (Note 3) ($I_C = -1.0 \text{ A}, I_B = -0.1 \text{ A}$)	V _{BE(sat)}			-1.0	V
Base – Emitter Turn–on Voltage (Note 3) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	V _{BE(on)}			-0.900	V
Cutoff Frequency (I _C = -500 mA, V _{CE} = -10 V, f = 100 MHz)	f _T		100		MHz
Input Capacitance (V _{EB} = 5.0 V, f = 1.0 MHz)	Cibo		360		pF
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	Cobo		60		pF

3. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle $\leq 2\%$.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

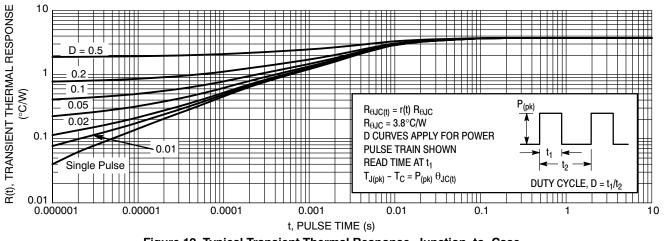
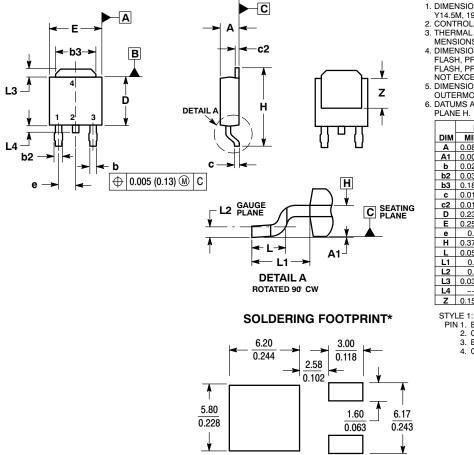


Figure 12. Typical Transient Thermal Response, Junction-to-Case

PACKAGE DIMENSIONS

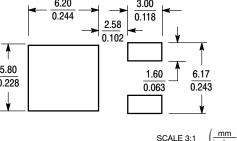
DPAK (SINGLE GAUGE) CASE 369C ISSUE D



NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCHES.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
- 5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. 6. DATUMS A AND B ARE DETERMINED AT DATUM

	INCHES		MILLIM	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.030	0.045	0.76	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
E	0.250	0.265	6.35	6.73	
е	0.090	BSC	2.29	BSC	
н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.108	REF	2.74 REF		
L2	0.020	BSC	0.51	BSC	
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		



PIN 1. BASE 2. COLLECTOR

inches

3. EMITTER 4. COLLECTOR

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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